

OLED DISPLAY MODULE

Product Specification

CUSTOMER	Standard	
PRODUCT NUMBER	DD-12864YO-5A	
CUSTOMER APPROVAL		Date

INTERNAL APPROVALS					
Product Mgr Doc. Control Electr. Eng					
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REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
А	03 Dec 07			First Issue	
В	18 Apr 08	10	3.3	Changed pin out information for BS1, BS2	
С	28 Nov 12	26	10	Add chapter 10 supported accessories	

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1 MAIN FEATURES

ITEM	CONTENTS
Display Format	128 x 64 Dots
Overall Dimensions	73.00 x 41.86 x 2.00 mm
Colour	Monochrome Yellow
Active Area	61.41 x 30.69 mm
Viewing Area	63.41 x 32.69mm
Display Mode	Passive Matrix (2.70")
Driving Method	1/64 duty
Driver IC	SSD1325
Operating temperature	-30 ~ +70
Storage temperature	-40 ~ +80

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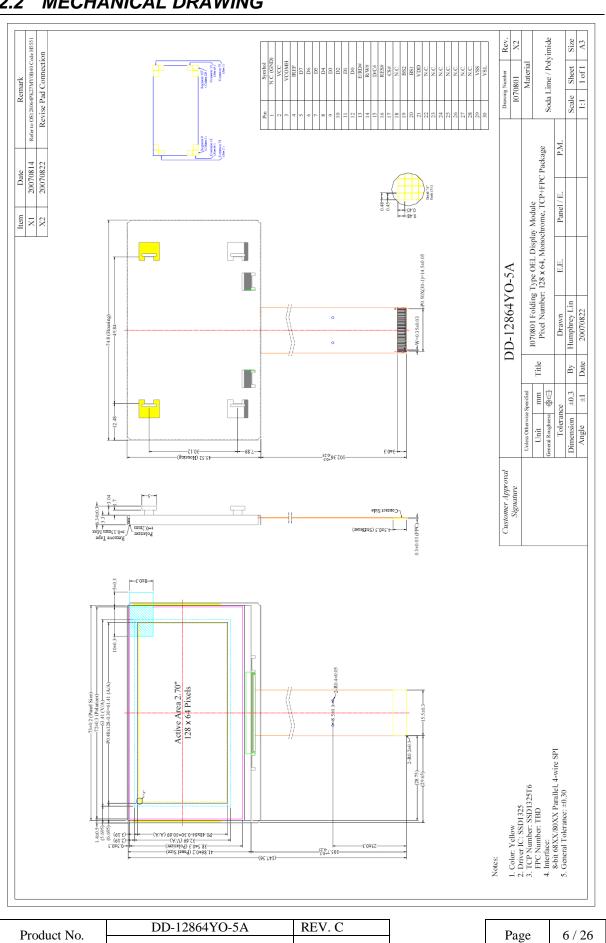


2 MECHANICAL SPECIFICATION

2.1 MECHANICAL CHARACTERISTICS

ITEM	CHARACTERISTIC	UNIT
Display Format	128 x 64 Dots	Dots
Overall Dimensions	73.00 x 41.86 x 2.00	mm
Viewing Area	63.41 x 32.69	mm
Active Area	61.41 x 30.69	mm
Dot Size	0.45 x 0.45	mm
Dot Pitch	0.48 x 0.48	mm
Weight	21	g
IC Controller/Driver	SSD1325	

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MECHANICAL DRAWING 2.2





3 ELECTRICAL SPECIFICATION

3.1 ABSOLUTE MAXIMUM RATINGS

				VSS =	$= 0 \text{ V}, \text{ Ta} = 25 \circ 0$
Item	Symbol	Min	Max	Unit	Note
Supply Voltage for logic	V _{DD}	-0.3	4.0	V	Note 1 2
Supply voltage for Display	Vcc	0	16	V	Note 1, 2
Operating Temperature	Тор	-30	70	°C	
Storage Temperature	Tst	-40	80	°C	
Static Electricity	Electricity Be sure that you are grounded when handling displays.				

Note 1: All the above voltages are on the basis of "GND=0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent damage to the module may occur. Also for normal operations it's desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics". If this module is used beyond these conditions the module may malfunction and the reliability could deteriorate.

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	V _{DD}		2.4	2.8	3.5	V
Supply Voltage for Display	Vcc	Note 3	14.25	15	15.75	V
High Level Input	V _{IH}		0.8xV _{DD}	-	V _{DD}	V
Low Level Input	V _{IL}	IOUT=0.1mA,	0	-	0.2 x VDD	V
High Level Output	V _{OH}	3.3MHz	0.9 x VDD	-	VDD	V
Low Level Output	V _{OL}		0	-	0.1 x Vdd	V
Operating exponent for Vap	Idd	Note 4	-	250	400	۸
Operating current for VDD		Note 5	-	250	400	μA
Operating assess for Ver	Inn	Note 4	-	31	39	
Operating current for Vcc	Icc	Note 5	-	53	66	mA
Sleep mode current for VDD	Idd sleep		-	1	2	μΑ
Sleep mode current for Vcc	ICC SLEEP		-	1	2	μΑ

3.2 ELECTRICAL CHARACTERISTICS

Note 3 Brigthness (L_{br}) and Supply Voltage for Display (V_{CC}) are subject to the change of the panel characteristics and the customers request

Note 4 $V_{DD} = 2.8V$, $V_{CC} = 15V$, 50% display area turned on.

Note 5 VDD = 2.8V, Vcc = 15V, 100% display area turned on.

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3.3 INTERFACE PIN ASSIGNMENT

No.	Symbol	Function
1	N.C.(GND)	Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.
2	VCC	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. It can be supplied externally or generated internally by using internal DC/DC voltage converter.
3	VCOMH	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. It can be supplied externally or internally. When VCOMH is generated internally, a capacitor should be connected between this pin and VSS.
4	IREF	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current at 10µA.
5~12	D7~D0	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK.
13	E/RD#	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when the pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
14	R/W#	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
15	D/C#	Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams. When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at SDIN will be transferred to the command register.
16	RES#	Power Reset for Controller and Driver This pin is reset signal input. When the pin is low, initialization of the chip is executed.
17	CS#	Chip Select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.
18	N.C.	No Connection
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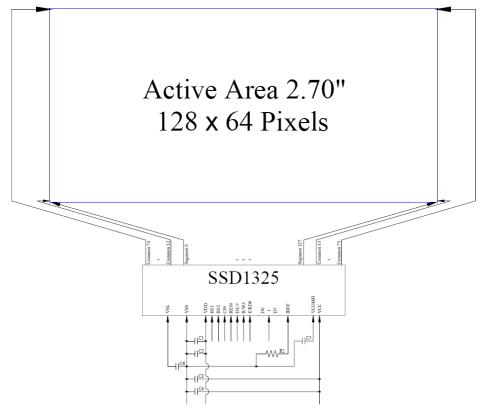


19	BS2	Communicating Protocol Select These pins are MCU interface selection input. See the following table:				
			68XX-parallel	80XX-parallel	Serial	
20 BS1		BS1	0	1	0	
	B21	BS2	1	1	0	
		-				
21	VDD		pply for Logic Cire			
21	VEE	This is a voltage supply pin. It must be connected to external source.				
		Reserved				
22~28	N.C.			the influences from s		
				e connected to exter	nal ground.	
			OEL System			
29	VSS				e logic pins, the OEL	
		ground.	iges, and the analog	circuits. It must be c	onnected to external	
			utput I ow I evel f	or SEG Signal		
30	VSL	Voltage Output Low Level for SEG Signal This pin is the output for the voltage output low level for SEG signals. A				
		capacitor should be connected between this pin and VSS.				

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BLOCK DIAGRAM



MCU Interface Selection: BS1 and BS2 Pins connected to MCU interface: D7~D0, E/RD#, R/W#, D/C#, RES# and CS#.

C1, C3:	0.1µF
C2, C6:	4.7μF
C4:	10µF
C5:	4.7µF/25V Tantalum Capacitor
R1:	820 kΩ, R1 = (Voltage at IREF – BGGND) / IREF

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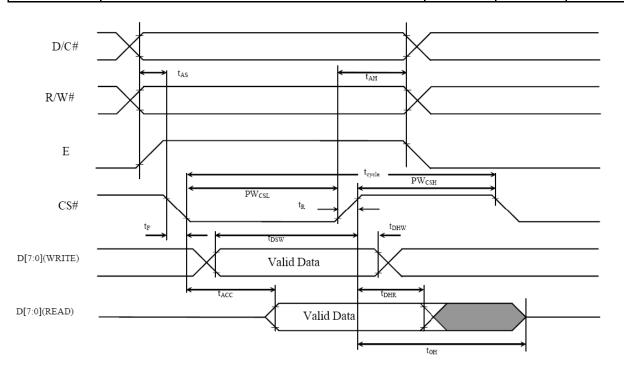
3.4 TIMING CHARACTERISTICS

3.4.1 AC CHARACTERISTICS

3.4.1.1 68XX-Series MPU Parallel Interface Timing Characteristics

 $VDD = 2.8V, Ta = 25^{\circ}C$

Symbol	Description	Min	Max	Unit
tcycle	System Cycle Time	300	-	ns
tAS	Address Setup Time	0	-	ns
tAH	Address Hold Time	0	-	ns
tDSW	Write Data Setup Time	40	-	ns
tDHW	Write Data Hold Time	15	-	ns
tDHR	Read Data Hold Time	20	-	ns
tOH	Output Disable Time	-	70	ns
tACC	Access Time	-	140	ns
PWCSL	Chip Select Low Pulse Width (Read) Chip Select	120		
PWCSL	Low Pulse width (Write)	60	-	ns
DWCGU	Chip Select High Pulse Width (Read) Chip Select	60		
PWCSH	High Pulse Width (Write)	60	-	ns
tR	Rise Time	-	15	ns
tF	Fall Time	-	15	ns

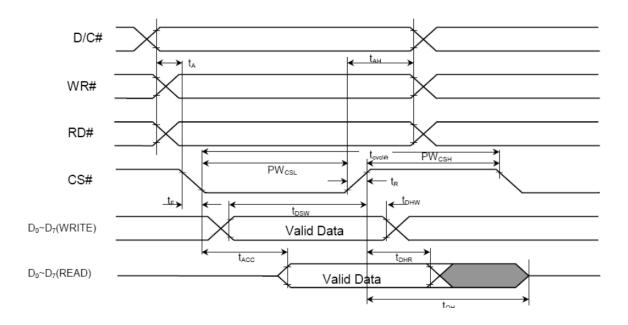


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Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	300	-	ns
tAS	Address Setup Time	0	-	ns
tAH	Address Hold Time	0	-	ns
tDSW	Write Data Setup Time	40	-	ns
tDHW	Write Data Hold Time	15	-	ns
tDHR	Read Data Hold Time	20	-	ns
tOH	Output Disable Time	-	70	ns
tACC	Access Time	-	140	ns
PWcsl	Chip Select Low Pulse Width (Read)	120	-	ns
F WCSL	Chip Select Low Pulse Width (Write)	60	-	ns
PWcsh	Chip Select Setup High Pulse Width (Read)	60	-	ns
PWCSH	Chip Select Setup High Pulse Width (Write)	60	-	ns
tR	Rise Time	-	15	ns
tF	Fall Time	-	15	ns

3.4.1.2 80XX-Series MPU Parallel Interface Timing Characteristics



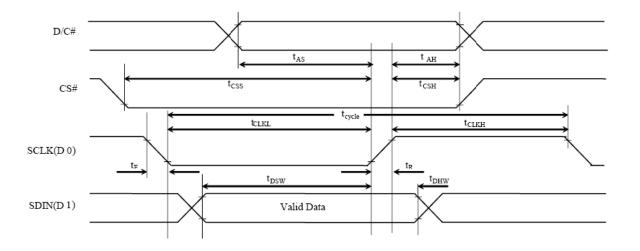
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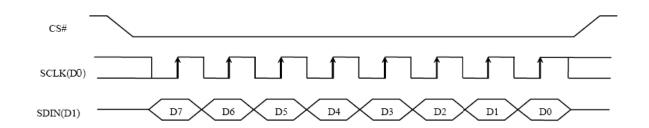


3.4.1.3 Serial Interface Timing Characteristics

VDD = 2.8V, Ta = $25^{\circ}C$

Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	250	-	ns
tAS	Address Setup Time	150	-	ns
tAH	Address Hold Time	150	-	ns
tCSS	Chip Select Setup Time	120	-	ns
tCSH	Chip Select Hold Time	60	-	ns
tDSW	Write Data Setup Time	100	-	ns
tDHW	Write Data Hold Time	100	-	ns
tCLKL	Serial Clock Low Time	100	-	ns
tCLKH	Serial Clock High Time	100	-	ns
tR	Rise Time	-	15	ns
tF	Fall Time	-	15	ns





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4 OPTICAL SPECIFICATION

4.1 OPTICAL CHARACTERISTICS

Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Brightness(White)	L _{br}	With Polarizer (Note 3)	70	100	-	cd/m ²
CIE (White)	(X)	Without Polarizer	0.44	0.48	0.52	
C.I.E.(White)	(Y)	without Polarizer	0.47	0.51	0.55	-
Dark Room Contrast	CR		-	>1000:1	-	-
Viewing Angle			>160	-	-	degree

Optical measurement taken at $V_{DD} = 2.8V$, $V_{CC} = 15V$. Software configuration follows Section 4.4 Initialization

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5 FUNCTIONAL SPECIFICATION

5.1 COMMANDS

Please refer to the Technical Manual for the SSD1325

5.2 POWER UP/DOWN SEQUENCE

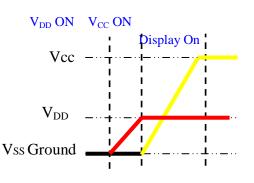
To protect panel and extend the panel lifetime, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the panel enough time to complete the action of charge and discharge before/after the operation.

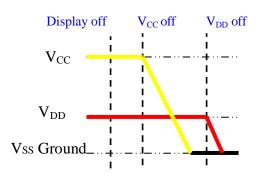
5.2.1 POWER UP SEQUENCE

Power up V_{DD}
 Send Display off command
 Initialization
 Clear Screen
 Power up Vcc
 Delay 100ms
 (when VDD is stable)
 Send Display on command



- 1. Send Display off command
- 2. Power down V_{CC}
- 3. Delay 100ms
 (When V_{PP} reach 0 and panel is completely discharges)
 4. Derver down V
- 4. Power down V_{DD}





5.3 RESET CIRCUIT

When RES# input is low, the chip is initialized with the following status:

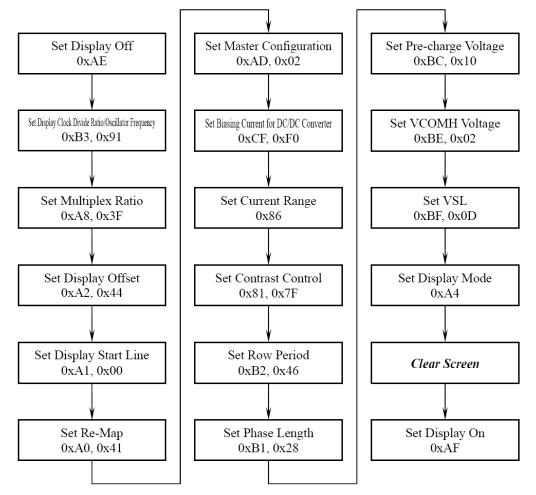
- 1. Display is OFF
- 2. 128x80 Display mode
- 3. Normal segment and display data column and row address mapping (SEG0 mapped to
- column address 00H and COM0 mapped to row address 00H)
- 4. Shift register data clear in serial interface
- 5. Display start line is set at display RAM address 0
- 6. Column address counter is set at 0
- 7. Normal scan direction of the COM outputs
- 8. Contrast control register is set at 80H
- 9. Normal display mode (Equivalent to A4h command)

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5.4 ACTUAL APPLICATION EXAMPLE

Command usage and explanation of an actual example

<Initialisation Setting>

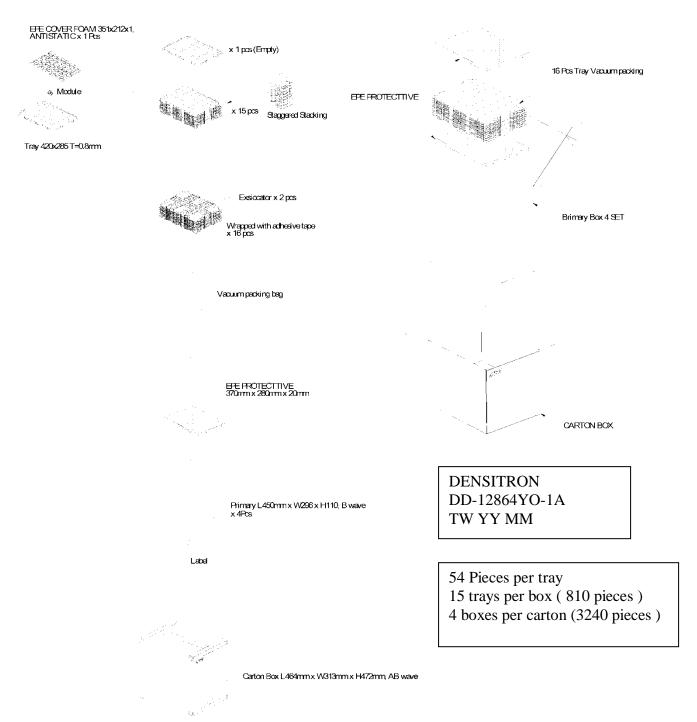


If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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6 PACKAGING AND LABELLING SPECIFICATION



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7 QUALITY ASSURANCE SPECIFICATION

7.1 CONFORMITY

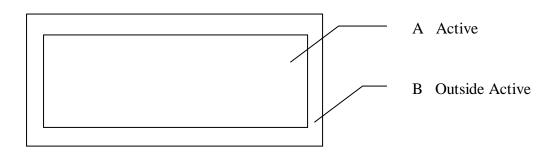
The performance, function and reliability of the shipped products conform to the Product Specification.

7.2 DELIVERY ASSURANCE

7.2.1 DELIVERY INSPECTION STANDARDS

IPC-AA610, class 2 electronic assemblies standard

7.2.2 Zone definition



7.2.3 Visual inspection

Test and measurement to be conducted under following conditions :

Temperature:	23±5°C
Humidity:	55±15%RH
Fluorescent lamp:	30 W
Distance between the Panel & Eyes of the Inspector:	≧30cm
Distance between the Panel & the lamp:	≧50cm

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7.2.4 Standard of appearance inspection

Units: mm

Class	Item			Criteria	l		
Minor	Packing &	Outside & ins	Dutside & inside package Presence of product no., lot no., quantity				
Critical	Label		Product must not be mixed with others and quantity must not be different from				
		that indicated					
Major	Dimension	Product dime	nsions must	be according to sp	becification and di	rawing	
Major	Electrical	Product electr	rical charact	teristics must be ac	cording to specifi	cation	
Critical	OLED Display	Missing lines allowed	, short circu	its or wrong patter	ns on OLED disp	lay are not	
Minor	Black spot, white spot,	Round type: a $\emptyset = (X+Y)/2$	-	ving drawing			
	dust			А	cceptable quantity	/	
				Size	Zone A	Zone B	
		+	-	Ø<0.1	Any number		
			Y	0.1<Ø<0.2	3	Any number	
			-	0.2<Ø<0.25	1	Any number	
		X		0.25<Ø	0		
		Line type: as	per followin Length	Acceptal Width	ole quantity Zone A	Zone B	
			L≤2.0	W≤0.05 W≤0.1	Any number 3	Any number	
			$\frac{L \leq 2.0}{L > 2.0}$	<u>w_0.1</u>	0	Any number	
				table quantity: 3			
Minor	Polariser	_		n is permitted			
	scratch	Scratch on po		e as No. 1			
Minor	Polariser	$\varnothing = (X+Y)/2$		· · · · ·	<u> </u>		
	bubble				cceptable quantity		
				Size	Zone A	Zone B	
		•	-	Ø<0.5 Ø>0.5	Any number 0	Any number	
		×X *	_ <u>1</u>	<u> </u>		1	

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Class	Item	Criteri	a	
Minor	Segment	1b. Pin hole on dot matrix display		
	deformation	₩ < <u>0.05</u>	Acceptable	e quantity
			Size	
			a,b<0.1	Any number
			(a+b)/2≤0.1	Any number
			0.5<Ø<1.0	3
			Total acceptable	quantity: 7
		2. Segments / dots with different width		
			Accep	table
			a≥b	a/b≤4/3
			a <b< td=""><td>a/b>4/3</td></b<>	a/b>4/3
		3. Alignment layer defect		
		$\emptyset = (a+b)/2$	Acceptable	e quantity
		C_	Size	
			Ø≤0.4	Any number
			0.4<Ø≤1.0	5
			1.0<Ø≤1.5	3
		FI EM F		2
			$\frac{1.5 < \emptyset \le 2.0}{\text{Total acceptable}}$	
Minor	Panel Chipping	$\begin{array}{c} X \leq 1/6 \text{ Panel length} \\ Y \leq 1 \\ Z \leq T \end{array}$		Z
Minor	Panel Cracking	Cracks not allowed		
Minor	Cupper exposed (pin or film)	Not allowed if visible by eye inspection		
Minor	Film or Trace Damage	Not allowed if affect electrical function		

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Class	Item		Crit	teria				
Minor	Contact Lead Twist	Not allowed		D. TVISTED LEAD				
Minor	Contact Lead Broken	Not allowed	Not allowed					
Minor	Contact Lead Bent	Not allowed if bent lead causes short circuit						
		Not allowed if bent extends horizontall more than 50% of its width						
Minor	Colour uniformity	Level of sample for	r approval set as limi	it sample				
Major	PCB	No unmelted solder	r paste should be pre	esent on PCB				
Critical		-	-	ections, or oxidation	are not allowed			
Minor		No residue or solde	er balls on PCB are a	allowed				
Critical	~~	Short circuits on co	omponents are not all					
Minor	Tray particles			Size	Quantity			
	1 narmetes			Ø<0.2	Any number			
	purificies		On tray	$\alpha > 0.25$	1			
	putteres		On tray On display	Ø>0.25 Ø≥0.25	4 2			

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7.3 DEALING WITH CUSTOMER COMPLAINTS

7.3.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

7.3.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of nonconforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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8 RELIABILITY SPECIFICATION

8.1 RELIABILITY TESTS

Test Item	Test Condition	Evaluation and assessment		
High Temperature Operation	70°C, 240 hours	No abnormalities in function and appearance		
Low Temperature Operation	-30°C, 240 hours	No abnormalities in function and appearance		
High Temperature Storage	80°C, 240 hours	No abnormalities in function and appearance		
Low Temperature Storage	-40°C, 240 hours	No abnormalities in function and appearance		
High Temperature & High Humidity Storage(Operation)	60°C, 90%RH, 240 hours	No abnormalities in function and appearance		
Thermal Shock	24 cycle of -40°C 1 Hour, 85°C 1 Hour. 60 Mins dwell	No abnormalities in function and appearance		

• The samples used for above tests do not include polarizer.

• No moisture condensation is observed during tests.

8.1.1 FAILURE CHECK STANDARD

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure teat at 23 ± 5 °C; $55\pm15\%$ RH

8.2 LIFE TIME

Item	Description				
1	Function, performance, appearance, etc. shall be free from remarkable deterioration more than 40,000 hours under 100 cd/m ² brightness and 50% Checkerboard, humidity (50% RH), and in area not exposed to direct sunlight.				
2	End of lifetime is specified as 50% of initial brightness.				

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9 HANDLING PRECAUTIONS

Safety

If the panel breaks, be careful not to get the organic substance in your mouth or in your eyes. If the organic substance touches your skin or clothes, wash it off immediately using soap and plenty of water.

Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

Design the system so that no input signal is given unless the power supply voltage is applied.

Caution during OLED cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface. Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to V_{DD} or V_{SS} . Do not input any signals before power is turned on.

Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

Packaging

Displays use OLED elements, and must be treated as such. Avoid strong shock and drop from a height.

To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.

Other Precautions

When a display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.

Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

Storage

Store the display in a dark place where the temperature is $25^{\circ}C \pm 10^{\circ}C$ and the humidity below 50% RH.

Store the display in a clean environment, free from dust, organic solvents and corrosive gases. Do not crash, shake or jolt the display (including accessories).

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10 SUPPORTED ACCESSORIES

10.1 DUO KIT

Densitron has developed an easy to use yet powerful development and demonstration tool for driving its range of Passive Matrix OLED displays from the USB port of a PC. DUO (Densitron USB OLED) kit is hot pluggable and does not require extra cables or power supply to run, allowing users to be up and running in minutes.

The kit consists of an OLED display with transition Board, USB controller card, mini USB cable and a CD with software application and drivers.



Part number: PDK-N-12864YO-5A

10.2 TRANSITION BOARD CARD

A Transition board card is like a daughterboard which is meant to be a circuit board for connections between the baseboards (DUO).

It has connector pins for interfacing between the display and the baseboards.

It also includes the OLED display.

Part number: PDT-N-12864YO-5A

10.3 CONNECTOR BOARD CARD

A Connector board card is also a daughterboard which is a circuit board for connection between a microprocessor or microcontroller (customer's system).

Part number: EVK-CONNECT-016

10.4 CONNECTOR

T	Type: ZIF connector								
	No. of connections	Pitch (mm)	Manufacturer	Manufacturer part no.	Distributor part no.				
	30	0.50	Omron	XF2M-3015-1A	Farnell/1112560 Digikey/ OR723CT-ND				

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